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# HAT2031T

Silicon N Channel Power MOS FET  
High Speed Power Switching

**HITACHI**

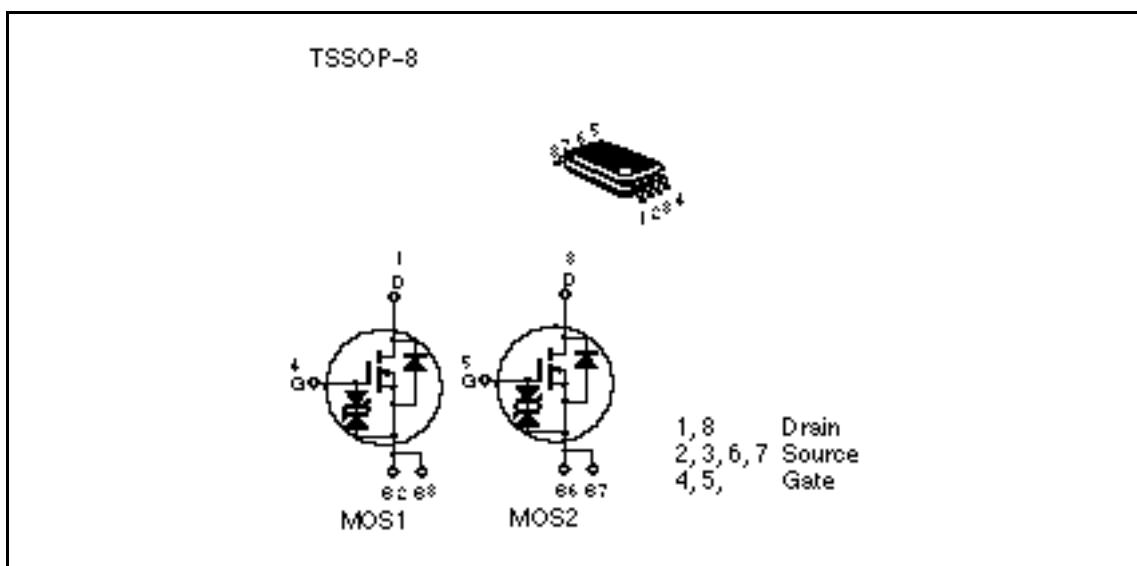
ADE-208-529 D (Z)  
5th. Edition  
July 1997

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## Features

- Low on-resistance
- Capable of 2.5 V gate drive
- Low drive current
- High density mounting

## Outline



## HAT2031T

### Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Drain to source voltage	V <sub>DSS</sub>	20	V
Gate to source voltage	V <sub>GSS</sub>	±12	V
Drain current	I <sub>D</sub>	3.5	A
Drain peak current	I <sub>D(pulse)</sub> <sup>Note1</sup>	28	A
Body-drain diode reverse drain current	I <sub>DR</sub>	3.5	A
Channel dissipation	P <sub>ch</sub> <sup>Note2</sup>	1	W
Channel dissipation	P <sub>ch</sub> <sup>Note3</sup>	1.5	W
Channel temperature	T <sub>ch</sub>	150	°C
Storage temperature	T <sub>tsg</sub>	-55 to +150	°C

Note: 1. PW 10μs, duty cycle 1 %

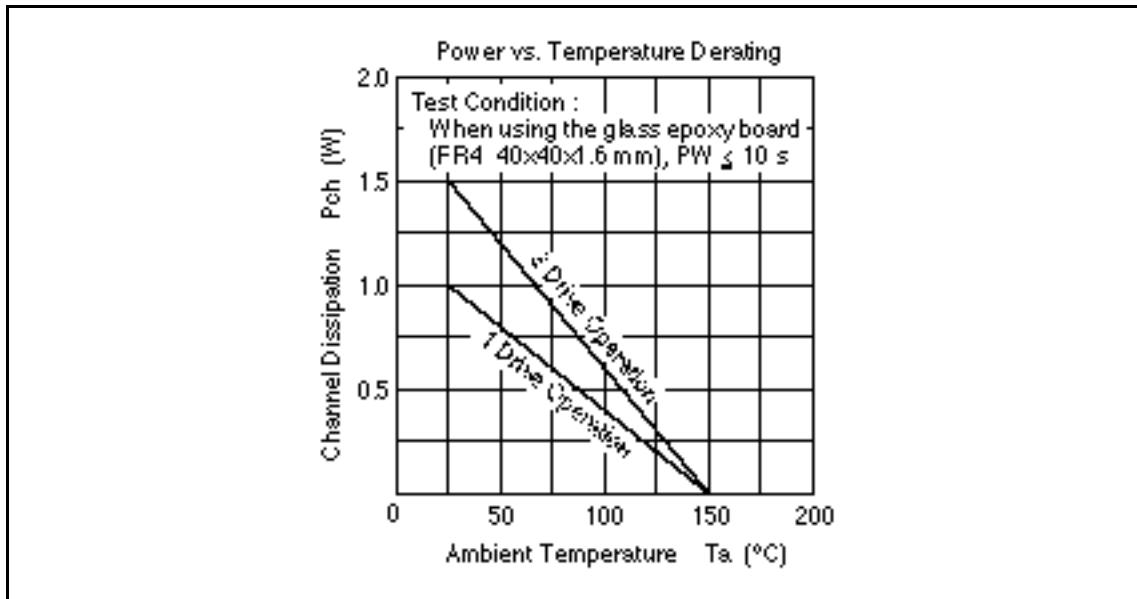
2. 1 Drive operation : When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW 10s

3. 2 Drive operation : When using the glass epoxy board (FR4 40 x 40 x 1.6 mm), PW 10s

### Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Typ	Max	Unit	Test Conditions
Drain to source breakdown voltage	V <sub>(BR)DSS</sub>	20	—	—	V	I <sub>D</sub> = 10mA, V <sub>GS</sub> = 0
Gate to source breakdown voltage	V <sub>(BR)GSS</sub>	±12	—	—	V	I <sub>G</sub> = ±100μA, V <sub>DS</sub> = 0
Gate to source leak current	I <sub>GSS</sub>	—	—	±10	μA	V <sub>GS</sub> = ±10V, V <sub>DS</sub> = 0
Zero gate voltage drain current	I <sub>DSS</sub>	—	—	1	μA	V <sub>DS</sub> = 20 V, V <sub>GS</sub> = 0
Gate to source cutoff voltage	V <sub>GS(off)</sub>	0.5	—	1.5	V	V <sub>DS</sub> = 10V, I <sub>D</sub> = 1mA
Static drain to source on state resistance	R <sub>DS(on)</sub>	—	0.054	0.070		I <sub>D</sub> = 2A, V <sub>GS</sub> = 4V <sup>Note4</sup>
Forward transfer admittance	y <sub>fs</sub>	4.5	7	—	S	I <sub>D</sub> = 2A, V <sub>DS</sub> = 10V <sup>Note4</sup>
Input capacitance	C <sub>iss</sub>	—	300	—	pF	V <sub>DS</sub> = 10V
Output capacitance	C <sub>oss</sub>	—	185	—	pF	V <sub>GS</sub> = 0
Reverse transfer capacitance	C <sub>rss</sub>	—	90	—	pF	f = 1MHz
Turn-on delay time	t <sub>d(on)</sub>	—	13	—	ns	V <sub>GS</sub> = 4V, I <sub>D</sub> = 2A
Rise time	t <sub>r</sub>	—	75	—	ns	V <sub>DD</sub> ÷ 10V
Turn-off delay time	t <sub>d(off)</sub>	—	60	—	ns	
Fall time	t <sub>f</sub>	—	75	—	ns	
Body-drain diode forward voltage	V <sub>DF</sub>	—	0.85	1.11	V	IF = 3.5A, V <sub>GS</sub> = 0 <sup>Note4</sup>
Body-drain diode reverse recovery time	t <sub>rr</sub>	—	35	—	ns	IF = 3.5A, V <sub>GS</sub> = 0 diF/dt = 20A/μs

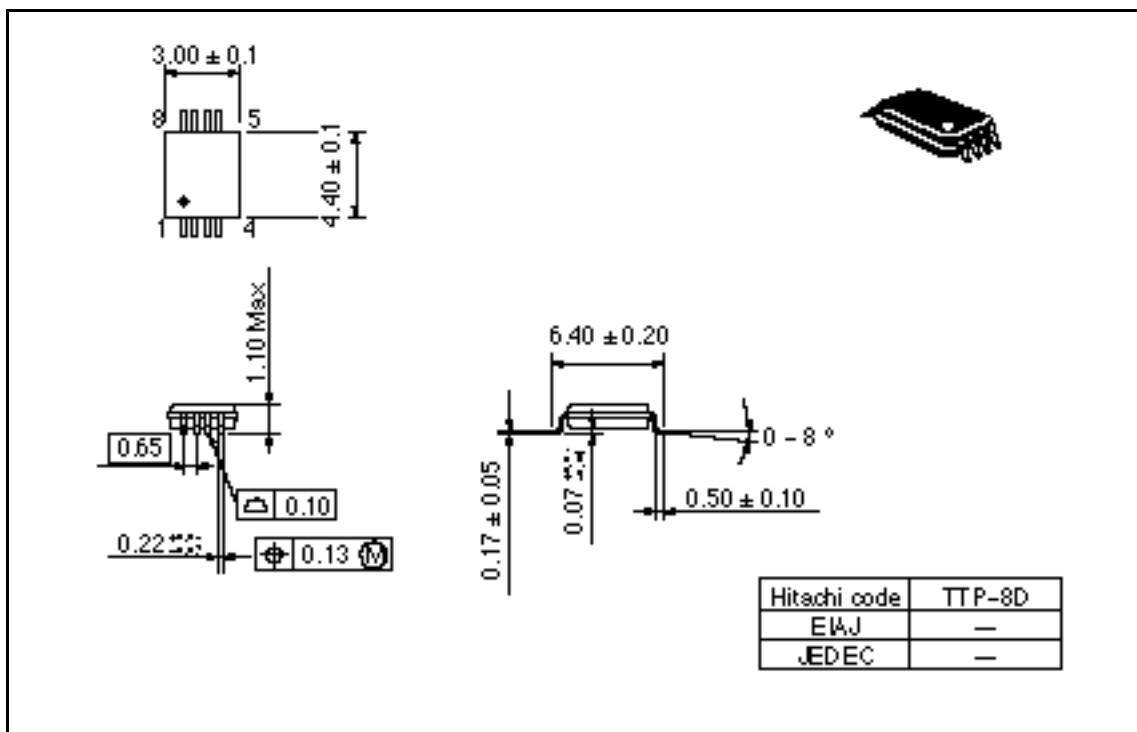
Note: 4. Pulse test

**Main Characteristics**

## HAT2031T

### Package Dimensions

Unit: mm



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